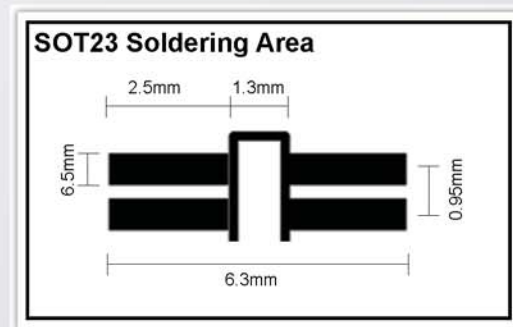
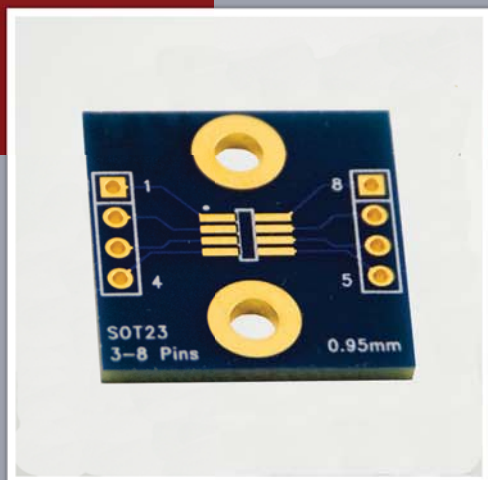


SOT23 Prototyping board

PT-SOT23



SOT23:
3-8 pins
0.95mm pitch

Hole Diameter:
0.047" (1.2mm)
plated holes

Hole Spacing:
0.1" (2.54mm)

T/H Pad:
0.08" (2.032mm)
round pad

Type/Finish:
FR-4 with
Electroless Nickel
Immersion Gold
(ENIG)

PCB Thickness:
0.062" (1.57mm)

Mounting Holes:
4-40 size, plated

The SOT23 prototyping boards are designed to allow quick and easy circuit prototyping of SOT23 chips ranging between 3 and 8 pins. The boards also offer 0.08" round pads with 0.047" plated holes spaced 0.1" apart which can be used to solder DIP headers or wires to interface with the chip. The spacing of the holes also allows the boards to be connected to a standard 0.1" pitch bread-board with ease.

Ordering Information

Part Number	No. of Pads	Board Dimensions
PT-SOT23	8	0.85" x 0.82"